PRODUCT	:	CAMERA MODULE
MODEL NO.	:	CM5668-B200SF-E
SUPPLIER	:	TRULY OPTO-ELECTRONICS LTD.
DATE	:	October 19, 2010

CERT. No. 946535
ISO9001
TL9000

SPECIFICATION

Revision: 1.0

CM5668-B200SF-E

If there is no special request from customer, TRULY OPTO-ELECTRONICS LTD. will not reserve the tooling of the product under the following conditions:
1.There is no response from customer in two years after TRULY OPTO-ELECTRONICS LTD. submit the samples;
2.There is no order in two years after the latest mass production.
And correlated data (include quality record) will be reserved one year more after tooling was discarded.

TRULY OPTO-ELECTRONICS LTD.: CUSTOMER:

Quality Assurance Department:_____ Approved by: Technical Department:_____	Approved by:

REVISION RECORD

REV NO.	REV DATE	CONTENTS	REMARKS
1.0	2010-10-19	First release	

CONTENTS

WRITTEN BY	CHECKED BY	APPROVED BY
HUANG WEI NA	WEI YOU XING	LIU TIE NAN

Key Information

Module No.		CM5668-B200SF-E
Module Size		6.5mm X 6.5mm X 4.13mm
Sensor Type		OV2655
Array Size	UXGA	1600 X 1200
Power supply	core	1.5VDC +/-5%
	Analog	2.45~3.0 VDC
	I/O	1.7V to 3.0V
Lens		1/5 inch 2Plastic+ IR
Focus(F.NO)		2.8
View Angle		64.4°
Image Area		2842μm x 2121μm
Object distance		80cm-infinity
Sensitivity		1030mV/Lux-sec
Pixel size		1.75μm x 1.75μm
IR Cutter		650+/-10nm
Sensor Temperature Range	operating	-20° C to 70° C
	Stable Image	0° C to 50° C
Output Formats		YUV(422/420)/YCbCr422 RGB565/555 8-/10-bit Raw RGB Data
Maximum Image Transfer Rate	UXGA	15 fps
	SVGA	30 fps
S/N Rate		37dB
Dynamic Range		66dB
substrate		FPC
IC Package		38-PIN CSP2
Sensor Power requirements	Active	250mW
	Standby	75μA
Fixed Pattern noise		<1% of Vpeak-to-peak
Scan Mode		Progressive
Dark current		4mV/sec @ 60℃
Package		Antistatic Plastic

Pin Assignment

No.	Name	Pin type	Description
1	PWDN	Input	power down (active high with internal pull-down resistor)
2	HREF	I/O	horizontal reference output
3	VSYNC	I/O	Vertical sync output
4	RESET	Input	reset (active low with internal pull-up resistor)
5	DVDD	Power	power for digital core
6	DOVDD	Power	power for I/O circuit
7	AVDD	Power	power for analog circuit/sensor array
8	AGND	Ground	Ground for analog circuit
9	PCLK	I/O	pixel clock output
10	DGND	Ground	Digital Ground
11	MCLK	Input	system input clock
12	DGND	Ground	Digital Ground
13	SIO_D	I/O	SCCB data
14	SIO_C	Input	SCCB input clock
15	Y9	I/O	Video port output bit[9] Default: Input
16	Y8	I/O	Video port output bit[8] Default: Input
17	Y7	I/O	Video port output bit[7] Default: Input
18	Y6	I/O	Video port output bit[6] Default: Input
19	Y2	I/O	Video port output bit[2] Default: Input
20	Y5	I/O	Video port output bit[5] Default: Input
21	Y3	I/O	Video port output bit[3] Default: Input
22	Y4	I/O	Video port output bit[4] Default: Input
23	Y1	I/O	Video port output bit[1] Default: Input
24	Y0	I/O	Video port output bit[0] Default: Input

Electrical Characteristics

1. Absolute Maximum Ratings

parameter		absolute maximum rating[a]
stable operating temperature		0°C to +50°C
operating temperature		-20°C to +70°C
supply voltage (with respect to ground)	V_{DD-A}	4.5V
	V_{DD-C}	3V
	V_{DD-IO}	4.5V
electro-static discharge (ESD)	human body model	2000V
	machine model	200V
all input/output voltages (with respect to ground)		-0.3V to V_{DD-IO} + 1V
lead-free temperature, surface-mount process		245°C
lead-free temperature, surface-mount process		245°C

a. Exceeding the absolute maximum ratings shown above invalidates all AC and DC electrical specifications and may result in permanent damage to the device.

2.DC Characteristics (-30℃<Ta<70℃)

symbol	parameter	min	typ	max	unit
supply					
V_{DD-A}	supply voltage (analog)	2.5	2.8	3.0	V
V_{DD-D}[a]	supply voltage (digital core)	1.425	1.5	1.575	V
V_{DD-IO}	supply voltage (digital I/O)	1.71	1.8	3.0	V
I_{DD-A}	active (operating) current		35	55	mA
I_{DD-IO}[b]			45	70	mA
$I_{DDS-SCCB}$	standby current		1	2	mA
$I_{DDS-PWDN}$			45	75	µA
digital inputs (typical conditions: AVDD = 2.8V, DVDD = 1.5V, DOVDD = 1.8V)					
V_{IL}	input voltage LOW			0.54	V
V_{IH}	input voltage HIGH	1.26			V
C_{IN}	input capacitor			10	pF
digital outputs (standard loading 25 pF)					
V_{OH}	output voltage HIGH	1.62			V
V_{OL}	output voltage LOW			0.18	V
serial interface inputs					
V_{IL}[c]	SCL and SDA	-0.5	0	0.54	V
V_{IH}[c]	SCL and SDA	1.26	1.8	2.3	V

a. using the internal regulator is strongly recommended for minimum power down currents

b. active current is based on sensor resolution at full size and full speed, with the MIPI function, the active current needs an additional 20mA.

c. based on DOVDD = 1.8V.

3. AC Characteristics (T_A=25℃, V_{DD-A}=2.8V)

symbol	parameter	min	typ	max	unit
ADC parameters					
B	analog bandwidth		30		MHz
DLE	DC differential linearity error		0.5		LSB
ILE	DC integral linearity error		1		LSB
	setting time for hardware reset			<1	ms
	setting time for software reset			<1	ms
	setting time for UXGA/SVGA mode change			<1	ms
	setting time for register setting			<300	ms

4. Timing Characteristics

symbol	parameter	min	typ	max	unit
oscillator and clock input					
f_{OSC}	frequency (XVCLK)	6	24	27(54[a])	MHz
t_r, t_f	clock input rise/fall time			5 (10[b])	ns

a. if using the internal clock pre-scaler

b. if using the internal PLL

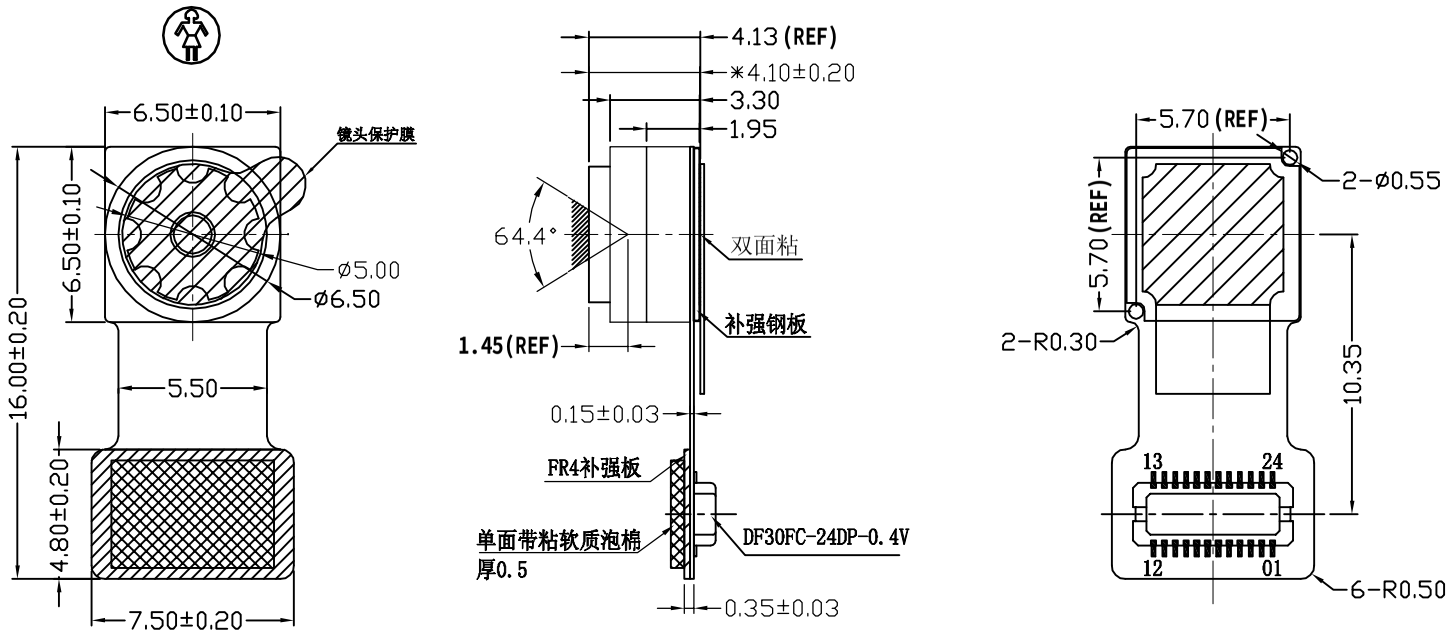
Note: For more information of sensor please refer to the OV2655 specification.

Mechanical Drawing

RoHS

Customer No.:

CM5668-B200SF-E Camera Module



24PIN DESCRIPTION

PIN NO.	SIGNAL
1	PWDN
2	HREF
3	VSYNC
4	RESET
5	DVDD
6	DOVDD
7	AVDD
8	AGND
9	PCLK
10	DGND
11	MCLK
12	DGND
13	SIOD
14	SIOC
15	Y9
16	Y8
17	Y7
18	Y6
19	Y5
20	Y4
21	Y3
22	Y2
23	Y1
24	Y0

主要参数(Module Specification)	
焦距(EFL)	3.02mm
光圈(F.NO)	2.8
视场角(View Angle)	64.4°
畸变(Distortion)	< 1 %
景深(Focusing Range)	80 cm~Infinity
感光芯片(Chip Type)	OV2655
象素(Array Size)	2.0M
镜头类型(lens Size)	1/5INCH 2P+IR

备注:

1.带*尺寸为关键尺寸;

2.未标注圆角为R0.2;

DVDD: 1.5V±5%
AVDD:2.45~3.0V
DOVDD:1.7~3.0V

CUSTOMER APPROVE		AMEND			手机摄像模组
Mechanical	Electrical	△			TOLERANCE DECIMAL .x ± .30 .xx ± .20 ∠ ± 1/4°
		△			
		△			
		1	增加连接器背部泡棉	20101008	
		NO.	CONTENT	DATE	

TRULY OPTO-ELECTRONICS LTD.

PRODUCT NO.	DRAW NO.	REV
CM5668-B200SF-E	CSHCCM2300	B

DWN 付全志 2010/09/29	DSN 付全志 2010/09/29
CHKD 杨永超 2010/09/29	APPD 刘铁楠 2010/09/29

NOT IN SCALE | UNIT mm | SHEET:

Appearance Specification

NO.	Item	Standard	Importance Class
1	Top side of Lens	No obvious impurity and oil impurity on the front of lens within the half area; The defect(unfeeling) limitation: width≤1mm, length≤2mm, the defect number≤2; No feeling defect; The width of defects and gaps on the outside of Lens≤0.3mm. Others are unlimited.	A
2	Screw glue	Normally screw glue shall be symmetrical distributed around lens circle side. Particular circs, glue distribution must not disturb customer's assembly operation.	A
3	L1 Glass	No defect and dust check from 45° angle under the reflexing light and from 0° under the highlight	A
4	Holder	No obvious impurity and distortion of outline. The width and length of defect is unlimited, the depth≤0.1mm and ≤1/4 of the thickness of Holder.	B
5	Sealed glue	Sealed glue distributing between holder and FPC must be symmetrical and smooth. Not allow glue leakage and asymmetric thickness. After holder assembly, the thickness distance between one side and its opposite side shall be less than 0.2mm. Excess glue over the holder shall not make the outside dimension be out of control.	A
6	FPC/PCB	Edge defect limitation: width≤1/2H (H is minimum.)、length≤1mm、defect numbers per edge≤2(No tearing gap inby edge for FPC); Edge outshoot limitation (width≤0.3mm, length≤1mm). No obvious impurity and crease on the surface. If there was shield film on the surface, the spot size of the film shall be less than 0.3mm×1mm and no line is exposed. If it was not be cleaned and did not influence the total thickness, it would be permitted. Label and mark shall be clear enough to be discerned.	A
7	Connector	No dust, fingerprint, and not allows to turning colors, distortion; Solder must be well; No open circuit or short circuit	A

8	Gold finger	No dust, fingerprint, and not allows to turning colors, burned, unsmoothed and peeled; No open circuit or short circuit; The defect width shall be smaller than 20% of gold finger's width. No copper/nickel exposed in defect. Numbers of defected pin shall be less than 3. The defect limitation:width≤0.08mm,length≤5mm.	A
9	Stiffener	Holder anchor pole length overtopping the steel plate shall be less than 0.2mm. No dust, rust and deep scratch on the steel surface without Double coated tapes.	B
10	Double coated tapes	Adhered direction shall be right. Not allows to excess steel plate edge. No alveoli and stick. Not allows to peel glue and rip protective paper when tear the protective paper.	B
11	Protective film	No dust in the glue side. Not allows to float or drop. Adhered direction shall be right.	B

Remark:

1. The definition of the appearance importance class

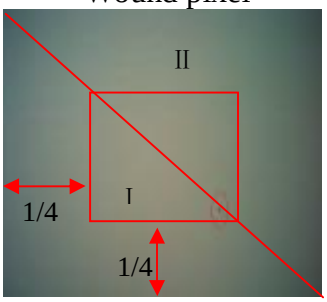
A: The defect can be found in the finished product, or have obvious visual differences from good products, such as crack, defect and dust, or influence image quality, or are appointed by the customer. We will emphasize these items and check all products.

B: The defect can be found in the finished product and has visual difference from the good one, but will not affect customer's aesthetic judgement. Or the defect can not be found in the finished product and will not generate functional problem, but will slightly influence sequential manufacture process or condition. We will supervise these items in the manufacturing process and check products selectively.

2. Sampling standard

Referenced standard: GB/T 2828.1-2003/ISO 2859-1:1999 and ANSI/ASQC.4-1993 Ⅱ

Image Specification

NO.	Item	Standard	Important Class
1	TV Line	Center≥700 8 point of 0.7 viewing field ≥550	A
2	Shading	The lighteness of 90% viewing area ≥ 40% of center lighteness(Lens correction Shading [Turn off]); The lighteness of 90% viewing area ≥ 60% of center lighteness(Lens correction Shading [Turn on])	A
3	Dust	No dust in the center viewing area; Border area according to the limit samples	A
4	Dead pixel	No in the viewing area.	A
5	Wound pixel 	Ⅰ area：Blemish number≤1 Ⅱ area：Blemish number≤4	B
6	Color	Color distortion ratio of center±15%	B
7	Gray Scale	Margin of two near scales' brightness≥6	B
8	Distortion	＜1%	B
9	Flare	No flare in 45° viewing angle; No ghost in full viewing angle	B

QA Plan

NO.	Item	Sampling frequency	Measure	Remark
Image and reliability item				
1	TV Line	AQL 0.65 Ⅱ Class	Same as production	100% Inspection
2	Shading	AQL 0.65 Ⅱ Class	Same as production	100% Inspection
3	Dust	AQL 0.65 Ⅱ Class	Same as production	100% Inspection
4	Dead pixel	AQL 0.65 Ⅱ Class	Same as production	100% Inspection
5	Wound pixel	AQL 1.5 Ⅱ Class	Same as production	100% Inspection
6	Color	AQL 1.5 Ⅱ Class	Same as production	100% Inspection
7	Gray Scale	AQL 1.5 Ⅱ Class	Same as production	100% Inspection
8	Distortion	N=5,c=0 per batch	Same as production	Sampling by QA
9	Flare	N=5,c=0 per batch	Same as production	Sampling by QA
Appearance Check Items				
1	Top side of Lens	AQL 1.0 Ⅱ Class	Same as production	100% Inspection
2	Screw glue	AQL 1.0 Ⅱ Class	Same as production	100% Inspection
3	L1 Glass	AQL 1.0 Ⅱ Class	Same as production	100% Inspection
4	Holder	AQL 1.5 Ⅱ Class	Same as production	100% Inspection
5	Sealed glue	AQL 1.0 Ⅱ Class	Same as production	100% Inspection
6	FPC/PCB	AQL 1.0 Ⅱ Class	Same as production	100% Inspection
7	Connector	AQL 1.0 Ⅱ Class	Same as production	100% Inspection
8	Gold finger	AQL 1.0 Ⅱ Class	Same as production	100% Inspection
9	Stiffener	AQL 1.5 Ⅱ Class	Same as production	100% Inspection
10	Double coated tapes	AQL 1.5 Ⅱ Class	Same as production	100% Inspection
11	Protective film	AQL 1.5 Ⅱ Class	Same as production	100% Inspection

Sample:

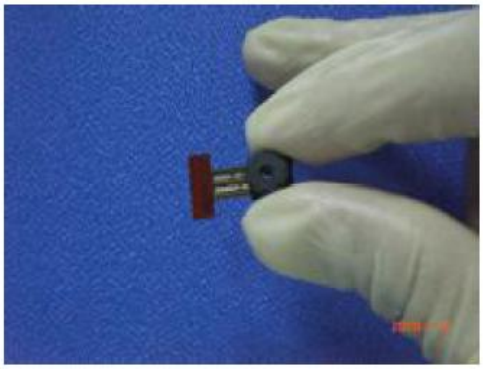
Referenced standard: GB/T 2828.1-2003/ISO 2859-1:1999 and ANSI/ASQC.4-1993 Ⅱ

PRECAUTIONS FOR USING CCM MODULES

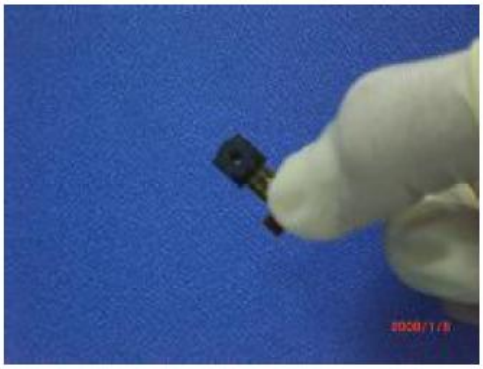
Handing Precautions

—DO NOT try to open the unit enclosure as there is no user-serviceable component inside. To prevent damage to the camera module by electrostatic discharge, handling the camera module only after discharging all static electricity from yourself and ensuring a static-free environment for the camera module.
—DO NOT touch the top surface of the lens.
—DO NOT press down on the lens.
—DO NOT try to focus the lens.
—DO NOT put the camera module in a dusty environment.
—To reduce the risk of electrical shock and damage to the camera module, turn off the power before connect and disconnect the camera module.
—DO NOT drop the camera module more than 60 cm onto any hard surface.
—DO NOT expose camera module to rain or moisture.
—DO NOT expose camera module to direct sunlight.
—DO NOT put camera in a high temperature environment.
—DO NOT use liquid or aerosol cleaners to clean the lens.
—DO NOT make any charges or modifications to camera module.
—DO NOT subject camera module to strong electromagnetic field.
—DO NOT subject the camera module to excessive vibration or shock.
—DO NOT Impact or nip CCM module with spiculate things
—DO NOT alter, modify or change the shape of the tab on the metal frame.
—DO NOT make extra holes on the printed circuit board, modify its shape or change the positions of components to be attached.
—DO NOT damage or modify the pattern writing on the printed circuit board.
—Absolutely DO NOT modify the zebra rubber strip (conductive rubber) or heat seal connector
—Except for soldering the interface, DO NOT make any alterations or modifications with a soldering iron.
—DO NOT twist FPC of CCM.

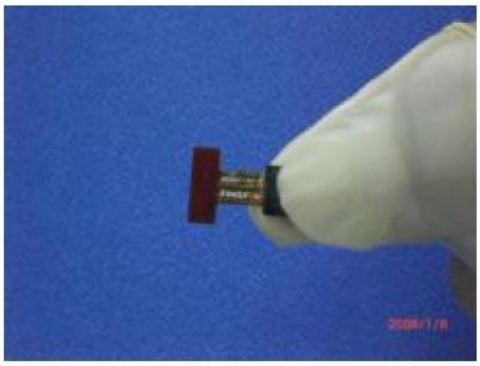
Apply indication



Correct



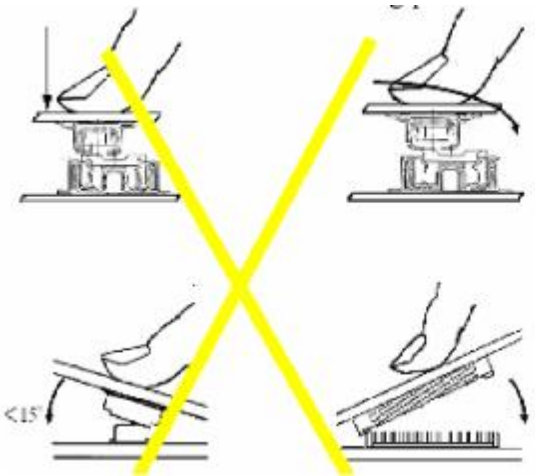
Incorrect

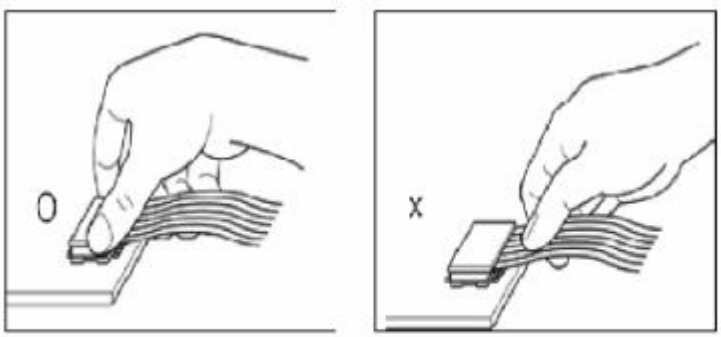


Incorrect

Precaution for assemble the module with BTB connector:

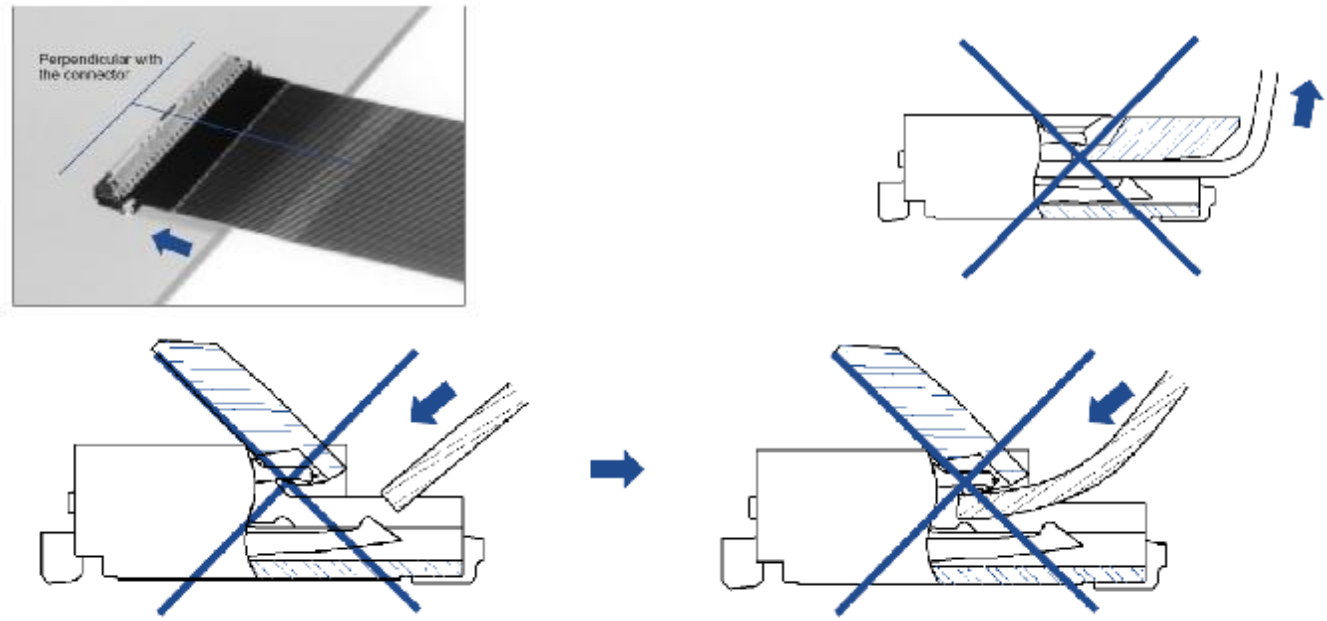
Please note the position of the male and female connector position, don't assemble or assemble like the method which the following picture shows





OK NG

Precaution for assemble the module with ZIF connector:



Precaution for soldering the CCM:

	Manual soldering	Machine drag soldering	Machine press soldering
No RoHS product	290˚C ~350˚C. Time: 3-5S.	330˚C ~350˚C. Speed: 4-8 mm/s.	300˚C ~330˚C. Time: 3-6S. Press: 0.8~1.2Mpa
RoHS product	340˚C ~370˚C. Time: 3-5S.	350˚C ~370˚C. Speed: 4-8 mm/s.	330˚C ~360˚C. Time: 3-6S. Press: 0.8~1.2Mpa

(1) If soldering flux is used, be sure to remove any remaining flux after finishing to soldering operation. (This does not apply in the case of a non-halogen type of flux.) It is recommended that you protect the lens surface with a cover during soldering to prevent any damage due to flux spatters.
(2) The CCM module and board should not be detached more than three times. This maximum number is determined by the temperature and time conditions mentioned above, though there may be some variance depending on the temperature of the soldering iron.

Other precautions

For correct using please refer to the relative criterions of electronic products.

Limited Warranty

Unless agreed between TRULY and customer, TRULY will replace or repair any of its CCM modules which are found to be functionally defective when inspected in accordance with TRULY CCM acceptance standards for a period of one year from date of shipments. Cosmetic/visual defects must be returned to TRULY within 90 days of shipment. Confirmation of such date shall be based on freight documents. The warranty liability of TRULY limited to repair and/or replacement on the terms set forth above. TRULY will not be responsible for any subsequent or consequential events.

Return CCM under warranty

No warranty can be granted if the precautions stated above have been disregarded. The typical examples of violations are:

-Holder is apart from module.
-Holder or Connector is anamorphic.
-Connector is turnup.
-FPC is lacerated or discon-nexion, and so on.

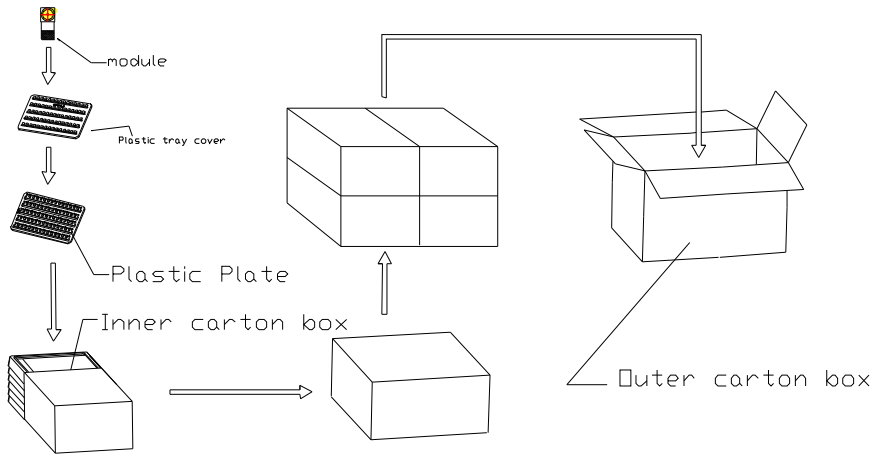
Module repairs will be invoiced to the customer upon mutual agreement. Modules must be returned with sufficient description of the failures or defects. Any connectors or cable installed by the customer must be removed completely without damaging the PCB eyelet, conductors and terminals.

Package Specification

Packaging Design One

Product No.	CM5668-B200SF-E	Release date			
Product name	Compact Camera Module	Releaser			
Supplier	TRULY OPTO-ELECTRONICS LTD.	Recycle		☐YES	■ NO
Quantity/ each box	TBD	Material for box		■ paper	☐ plastic
Outer carton box size	405mm*290mm*290mm	Box type		■new	☐update
Quantity / inner box * Quantity / outer box	TBD	Weight	g / pcs Kg / outer box	BOX=TYPE Record of SRF Dept.	TBD Kg(Max)

Packing Standards:



There are TBD modules each plastic plate.

There are TBD modules each inner carton box..

There are TBD modules each outer carton box.

Requirements of outer carton box :

1. Weight(Max): 0.75 Kg
2. Height (Max): 0.29 M
3. Prohibition: Box made by log

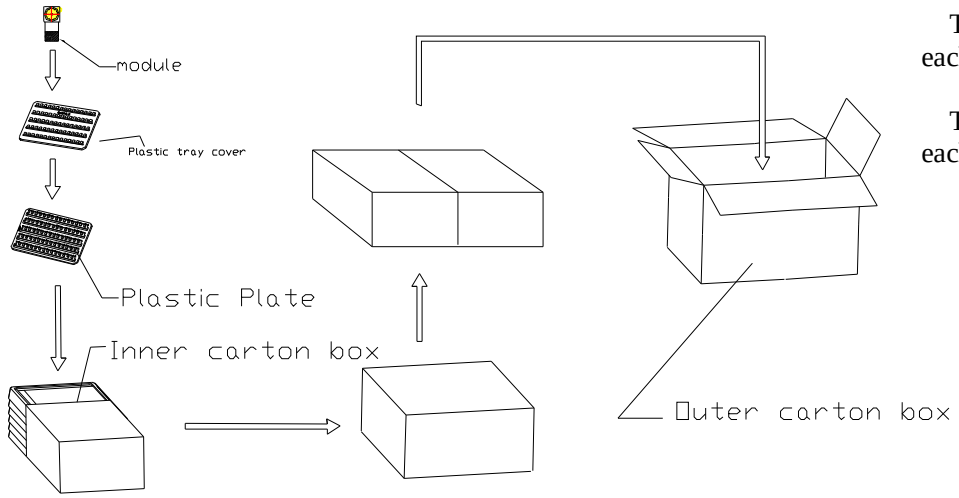
Material for Plastic tray

It is made of antistatic polystyrene which has no chemical pollution. Surface resistivity : 10^6 ohm/sq

Packaging Design Two

Product No.	CM5668-B200SF-E	Release date			
Product name	Compact Camera Module	Releaser			
Supplier	TRULY OPTO-ELECTRONICS LTD.	Recycle		☐YES	■ NO
Quantity/ each box	TBD	Material for box		■ paper	☐ plastic
Outer carton box size	405 mm *280 mm *170 mm	Box type		■new	☐update
Quantity / inner box * Quantity / outer box	TBD	Weight	g / pcs Kg / outer box	BOX=TYPE Record of SRF Dept.	TBD Kg(Max)

Packing Standards:



There are TBD modules each plastic plate.

There are TBD modules each inner carton box..

There are TBD modules each outer carton box.

Requirements of outer carton box :

4. Weight(Max): 0.65 Kg
5. Height (Max): 0.17 M
6. Prohibition: Box made by log

Material for Plastic tray

It is made of antistatic polystyrene which has no chemical pollution. Surface resistivity : 10^6 ohm/sq

PRIOR CONSULT MATTER

1.①For Truly standard products, we keep the right to change material, process for improving the product property without notice on our customer.
②For OEM products, if any change needed which may affect the product property, we will consult with our customer in advance.
2. If you have special requirement about reliability condition, please let us know before you start the test on our samples.

FACTORY CONTACT INFORMATION

FACTORY NAME: TRULY OPTO-ELECTRONICS LTD.
FACTORY ADDRESS: Truly Industrial Area, ShanWei City, GuangDong, China
FACTORY PHONE: 86-0660-3380061 FAX: 86-0660-3371772